Fab notes:
1. Material: 0.062" FR-4 glass epoxy, 1 oz copper
2. This is a 2-layer PCB
3. Route to indicated dimensions (in mm) +/- 0.1mm
4. Minimum lines 0.016", spaces 0.008"
5. Soldermask over bare copper, red color, both sides
6. Remove silkscreen from soldermask opening areas

7. Silkscreen legend comp side, white
8. All holes plated through 0.001" minimum unless specified
9. Hole diameters after plating, +/- 0.004"
10. Minimum plated hole size 0.032"
11. May change silkcreen width per process requirements
12. May change soldermask openings per process requirements